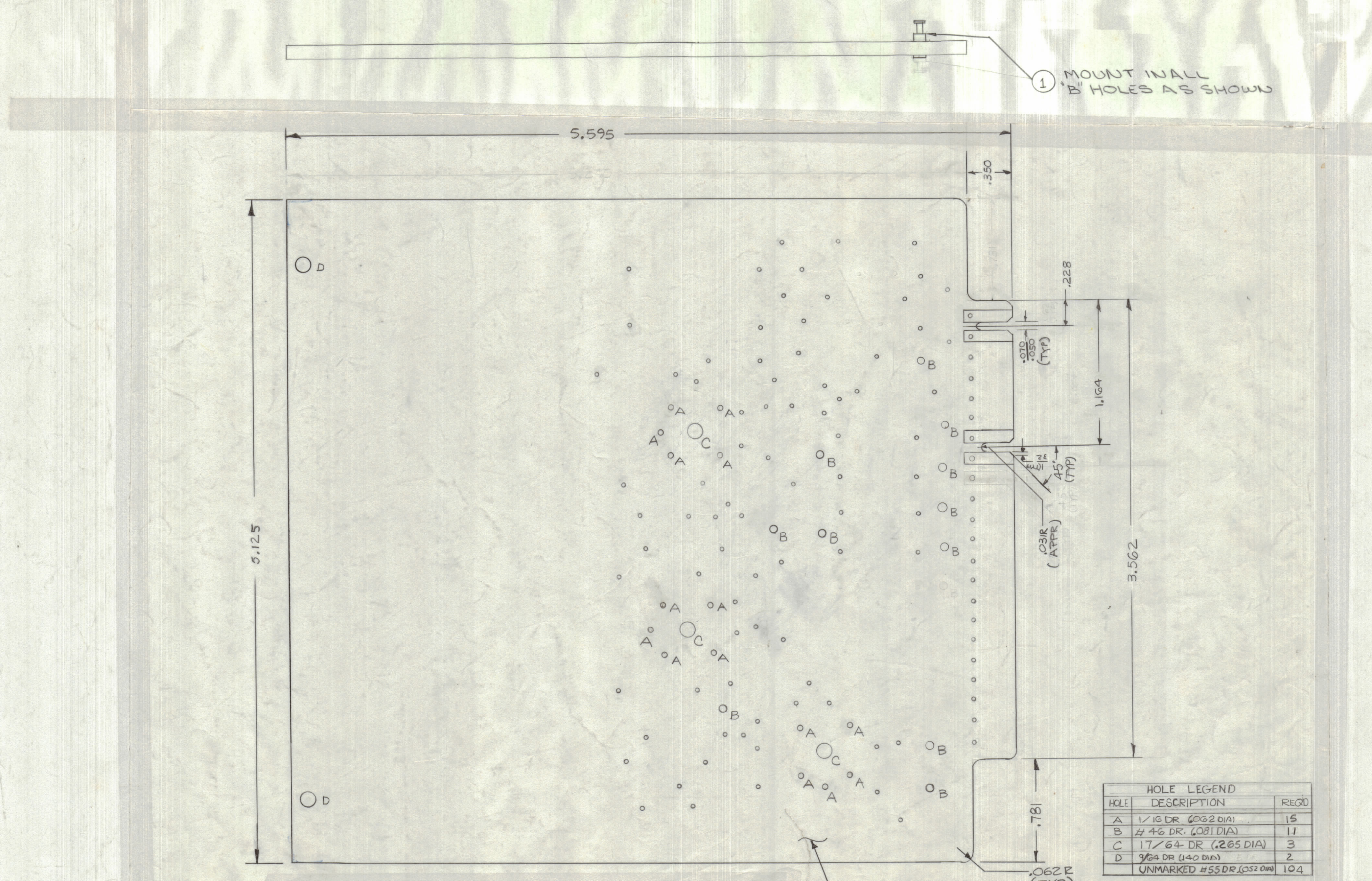


REVISIONS							
ZONE	SYM	DESCRIPTION	DATE	E.M.N. NO.	DRAFT	CHKD	APPD
X		EXP. RELEASE	5-13-64		CTL		
		ORIGINAL RELEASE FOR PRODUCTION	5-13-64		CTL		
A		FABRICATION NOTE REVISED	6/10/64	14226			
B		DWG WAS @ SIZE, SIDE VIEW IT ADDED SEE SH. D	7-14-64	14566			
C		4 UNMARKED HOLES DELETED. SEE SHEET 2	5-11-64	16238	GDL		
D		ADD CHART INCL. .062 THICKNESS	5-10-64	21647			



HOLE LEGEND		
HOLE	DESCRIPTION	REQD
A	1/16 DR (.032 DIA)	15
B	#46 DR (.081 DIA)	11
C	17/64 DR (.265 DIA)	3
D	9/64 DR (.140 DIA)	2
	UNMARKED #55 DR (.052 DIA)	104

FABRICATION NOTE:
 TO BE MANUFACTURED IN ACCORDANCE WITH TMC SPEC.
 S-735, EXCEPT AS NOTED.
 1. MATERIAL G-10 EPOXY GLASS LAMINATED .003 ± .0015 THICKNESS.
 2. OUNCE COPPER CLAD BOTH SIDES. (SEE CHART FOR THICKNESS)
 3. CONDUCTOR PATTERN SHALL BE SOLDER COATED AS PER PP.13.2.1
 4. HOLES TO BE PLATED THROUGH AS PER PP.11.4 EXCEPT FOR 3" A HOLES.
 5. EDGE BOARD CONNECTORS (FINGERS) SHALL BE GOLD PLATED AS PER PP.10.1.
 6. KEY SLOTS TO BE DEBURRED.

TMC PART NO.	THICKNESS
PC208	.093 ± .0075
PC208-1	.062 ± .0062

PC208
D

HOLE LEGEND		
HOLE	DESCRIPTION	REQD
A	1/16 DR (.032 DIA)	15
B	#46 DR (.081 DIA)	11
C	17/64 DR (.265 DIA)	3
D	9/64 DR (.140 DIA)	2
	UNMARKED #55 DR (.052 DIA)	104

CIRCUIT SIDE

REQ'D.	ITEM	PART NUMBER	DESCRIPTION	SYMBOL
11	1	TE127-2	STUD - TERMINAL	

LIST OF MATERIAL	
MATERIAL	SEE NOTE
FINISH	TITLE

THE TECHNICAL MATERIEL CORP.	
MAMARONECK, NEW YORK	
TITLE PRINTED CIRCUIT BOARD OUTPUT AMP	

SCALE	CODE	ASSY. NO.
1/16	A	

UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES	DRAWN	DATE	FINAL APPROVAL	DATE
	SEANZA	5/16/64	DAVE MANN	5/16/64

DECIMALS	FRACTIONS	ELECT. DES.	DATE	MECH. DES.	DATE
.x ± .03	± 1/64		5/16/64		5/16/64
.xx ± .01	± 1/32				
.xxx ± .005	± 0° 30'				

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NOTES